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R sp ns Under 37 C.F.R. 1.116
Exp dited Proc dur Examining Group 2841

PATENT
Atty. Docket No. 0630-1210P

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Jae-Choon LEE et al. Conf. No.: 7426
Appln. No.: 09/764,208 Group: 2841
Filed: January 19, 2001 Examiner: D.E. LEVI
For: ONE SYSTEM MODULE

#7/A
8/29/02
J.W.
(N.E.)
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TECHNOLOGY CENTER 2800
AUG 26 2002

AMENDMENT AFTER FINAL REJECTION

Assistant Commissioner for Patents
Washington, D.C. 20231

August 22, 2002

Sir:

In response to the Examiner's final Office Action dated May 22, 2002, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

In The Claims

Please amend claims 1, 3 and 5-6 as follows:

1. (Amended) A one system module in which a ceramic printed circuit board (PCB) and an epoxy PCB are disposed inside a module body, a power